

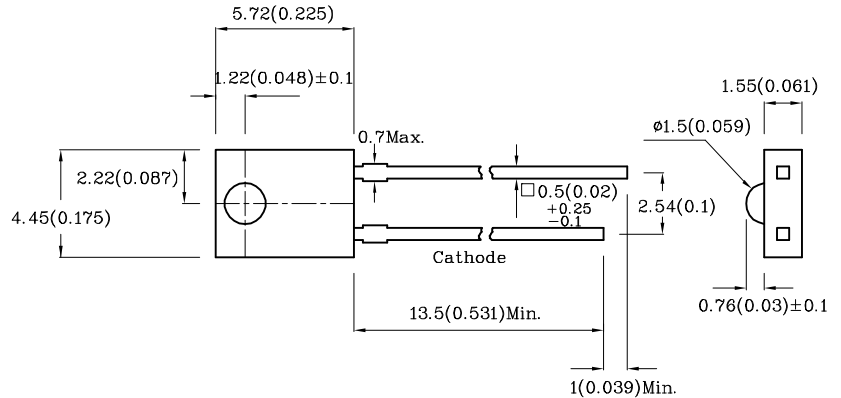
## Features

- Radial / Through hole package
- Reliable & robust
- Low power consumption
- Halogen-free
- RoHS compliant

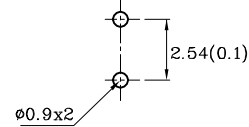


**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
DISCHARGE  
SENSITIVE  
DEVICES

## Package Schematics



Recommended PCB Layout



### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
3. Specifications are subject to change without notice.

| Absolute Maximum Ratings<br>(TA=25°C)                          |                     | Red<br>(AlGaInP) | Unit |
|--|---------------------|------------------|------|
| Reverse Voltage  | VR                  | 5                | V    |
| Forward Current  | IF                  | 30               | mA   |
| Forward Current (Peak)<br>1/10 Duty Cycle<br>0.1ms Pulse Width | IFP                 | 185              | mA   |
| Power Dissipation  | PD                  | 75               | mW   |
| Operating Temperature  | TA                  | -40 ~ +85        | °C   |
| Storage Temperature  | Tstg                | -40 ~ +85        |      |
| Lead Solder Temperature<br>[2mm Below Package Base]            | 260°C For 3 Seconds |                  |      |
| Lead Solder Temperature<br>[5mm Below Package Base]            | 260°C For 5 Seconds |                  |      |

| Operating Characteristics<br>(T <sub>A</sub> =25°C)                              |                | Red<br>(AlGaInP) | Unit |
|--|----------------|------------------|------|
| Forward Voltage (Typ.)<br>(I <sub>F</sub> =20mA)                                 | V <sub>F</sub> | 1.95             | V    |
| Forward Voltage (Max.)<br>(I <sub>F</sub> =20mA)                                 | V <sub>F</sub> | 2.5              | V    |
| Reverse Current (Max.)<br>(V <sub>R</sub> =5V)                                   | I <sub>R</sub> | 10               | µA   |
| Wavelength of Peak<br>Emission CIE127-2007* (Typ.)<br>(I <sub>F</sub> =20mA)     | λ <sub>P</sub> | 645*             | nm   |
| Wavelength of Dominant<br>Emission CIE127-2007* (Typ.)<br>(I <sub>F</sub> =20mA) | λ <sub>D</sub> | 630*             | nm   |
| Spectral Line Full Width<br>At Half-Maximum (Typ.)<br>(I <sub>F</sub> =20mA)     | Δλ             | 28               | nm   |

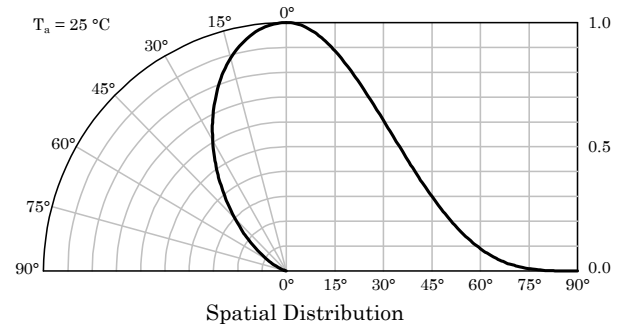
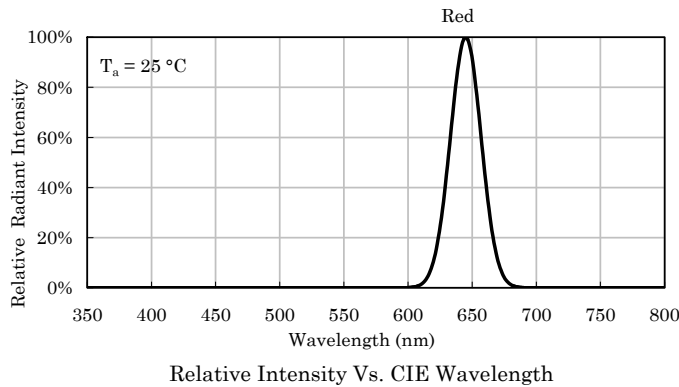
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

| Part<br>Number | Emitting<br>Color | Emitting<br>Material | Lens-color  | Luminous Intensity<br>CIE127-2007*<br>(I <sub>F</sub> =20mA)<br>mcd |             | Wavelength<br>CIE127-2007*<br>nm<br>λ <sub>P</sub> | Viewing<br>Angle<br>2θ 1/2 |
|----------------|-------------------|----------------------|-------------|---|-------------|--|----------------------------|
|                |                   |                      |             | min.  | typ.        |  |                            |
| XLMDK04W-R     | Red               | AlGaInP              | Water Clear | 700<br>200*   | 995<br>397* | 645*   | 70°                        |

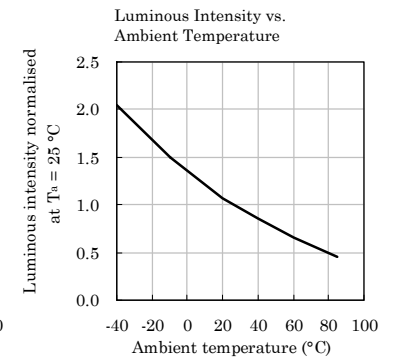
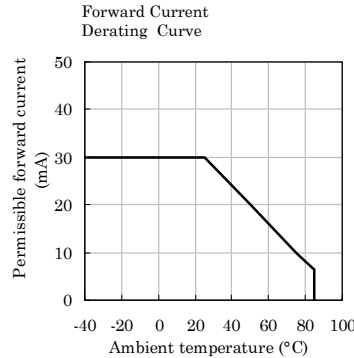
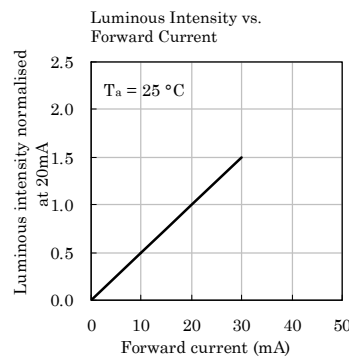
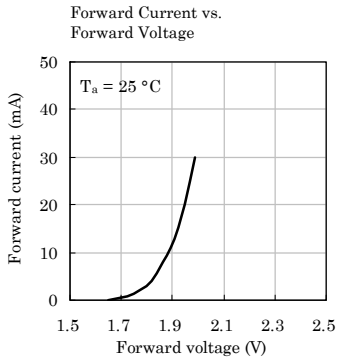
\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Nov 27,2025

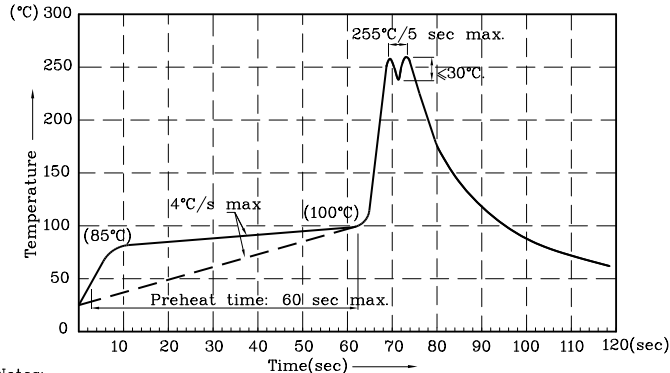
XDSB6700 V6-X Layout: Maggie L.



## ❖ Red



## Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



### Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

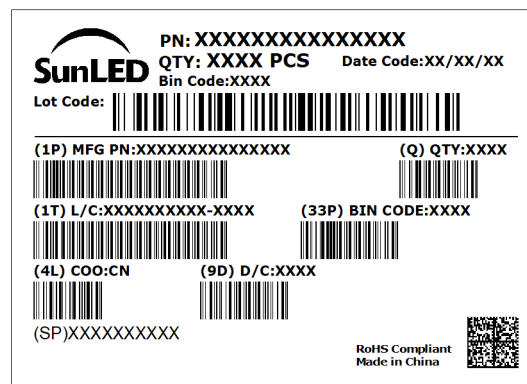
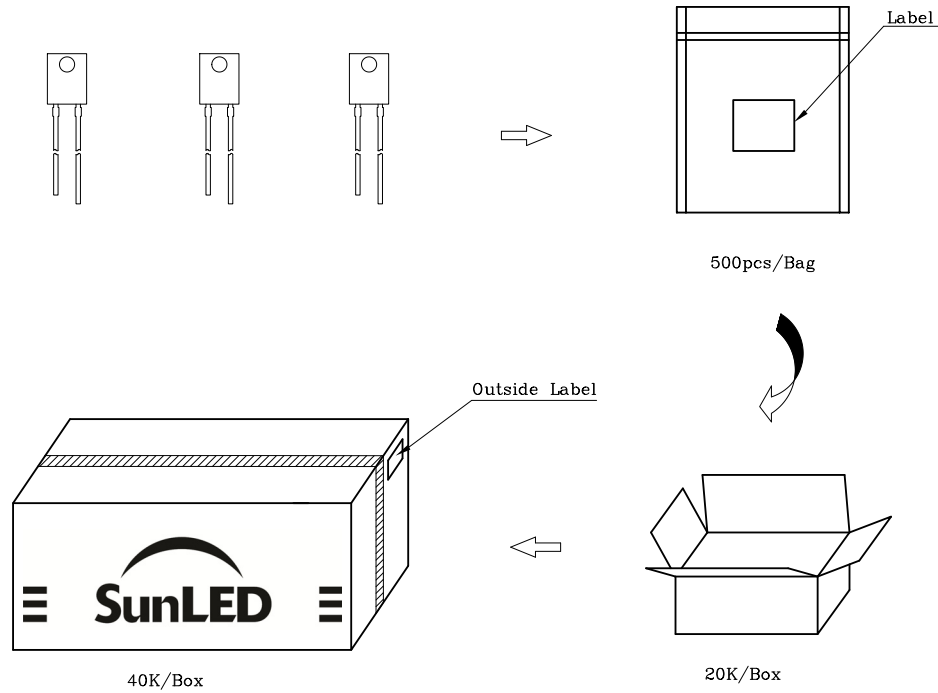
### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

## PACKING & LABEL SPECIFICATIONS



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2. Contents within this document are subject to improvement and enhancement changes without notice.
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